



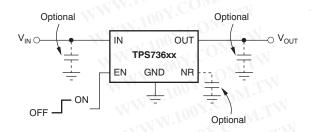
Cap-Free, NMOS, 400mA Low-Dropout Regulator with Reverse Current Protection

FEATURES

- Stable with No Output Capacitor or Any Value or Type of Capacitor
- Input Voltage Range of 1.7V to 5.5V
- Ultra-Low Dropout Voltage: 75mV typ
- Excellent Load Transient Response—with or without Optional Output Capacitor
- New NMOS Topology Delivers Low Reverse Leakage Current
- Low Noise: 30μV_{RMS} typ (10Hz to 100kHz)
- 0.5% Initial Accuracy
- 1% Overall Accuracy Over Line, Load, and Temperature
- Less Than 1μA max I_O in Shutdown Mode
- Thermal Shutdown and Specified Min/Max Current Limit Protection
- Available in Multiple Output Voltage Versions
 - Fixed Outputs of 1.20V to 5.0V
 - Adjustable Output from 1.20V to 5.5V
 - Custom Outputs Available

APPLICATIONS

- Portable/Battery-Powered Equipment
- Post-Regulation for Switching Supplies
- Noise-Sensitive Circuitry such as VCOs
- Point of Load Regulation for DSPs, FPGAs, ASICs, and Microprocessors

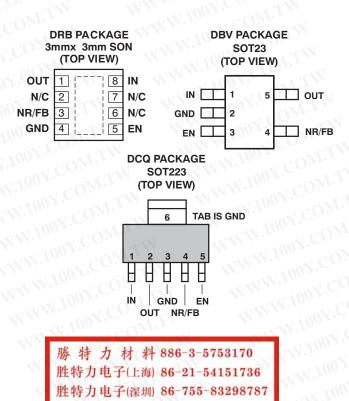


Typical Application Circuit for Fixed-Voltage Versions

DESCRIPTION

The TPS736xx family of low-dropout (LDO) linear voltage regulators uses a new topology: an NMOS pass element in a voltage-follower configuration. This topology is stable using output capacitors with low ESR, and even allows operation without a capacitor. It also provides high reverse blockage (low reverse current) and ground pin current that is nearly constant over all values of output current.

The TPS736xx uses an advanced BiCMOS process to yield high precision while delivering very low dropout voltages and low ground pin current. Current consumption, when not enabled, is under $1\mu A$ and ideal for portable applications. The extremely low output noise ($30\mu V_{RMS}$ with $0.1\mu F$ C_{NR}) is ideal for powering VCOs. These devices are protected by thermal shutdown and foldback current limit.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

PRODUCT	V _{out} ⁽²⁾
TPS736xx <i>yyyz</i>	XX is nominal output voltage (for example, 25 = 2.5V, 01 = Adjustable ⁽³⁾). YYY is package designator. Z is package quantity.

- (1) For the most current specification and package information, refer to the Package Option Addendum located at the end of this datasheet or see the TI website at www.ti.com.
- (2) Most output voltages of 1.25V and 1.3V to 5.0V in 100mV increments are available on a quick-turn basis using innovative factory EEPROM programming. Minimum order quantities apply; contact factory for details and availability.
- (3) For fixed 1.20V operation, tie FB to OUT.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

PARAMETER	TPS736xx	UNIT
V _{IN} range	-0.3 to 6.0	W. V.
V _{EN} range	-0.3 to 6.0	V.CO.
V _{OUT} range	-0.3 to 5.5	CONV
V _{NR} , V _{FB} range	-0.3 to 6.0	N. O. V. T.
Peak output current	Internally limited	100Y. C. T.T.
Output short-circuit duration	Indefinite	W. COP. TW
Continuous total power dissipation	See Dissipation Rating	gs Table
Junction temperature range, T _J	-55 to +150	°C M
Storage temperature range	-65 to +150	°C C
ESD rating, HBM	C 2	kV
ESD rating, CDM	500	ANIM A COM.

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under the Electrical Characteristics is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

POWER DISSIPATION RATINGS(1)

BOARD	PACKAGE	$R_{\theta JC}$	$R_{\theta JA}$	DERATING FACTOR ABOVE T _A = 25°C	T _A ≤ 25°C POWER RATING	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
Low-K ⁽²⁾	DBV	64°C/W	255°C/W	3.9mW/°C	390mW	215mW	155mW
High-K ⁽³⁾	DBV	64°C/W	180°C/W	5.6mW/°C	560mW	310mW	225mW
Low-K ⁽²⁾	DCQ	15°C/W	53°C/W	18.9mW/°C	1.89W	1.04W	0.76W
High-K ⁽³⁾	DCQ	15°C/W	45°C/W	22.2mW/°C	2.22W	1.22W	0.89W
High-K ⁽³⁾⁽⁴⁾	DRB	1.2°C/W	40°C/W	25.0mW/°C	2.50W	1.38W	1.0W

- (1) See Power Dissipation in the Applications section for more information related to thermal design.
- (2) The JEDEC Low-K (1s) board design used to derive this data was a 3inch x 3inch, 2-layer board with 2-ounce copper traces on top of the board.
- (3) The JEDEC High-K (2s2p) board design used to derive this data was a 3inch x 3inch, multilayer board with 1-ounce internal power and ground planes and 2-ounce copper traces on the top and bottom of the board.
- (4) Based on preliminary thermal simulations.

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ELECTRICAL CHARACTERISTICS

Over operating temperature range (T_J = -40° C to +125°C), V_{IN} = V_{OUT(nom)} + 0.5V⁽¹⁾, I_{OUT} = 10mA, V_{EN} = 1.7V, and C_{OUT} = 0.1 μ F, unless otherwise noted. Typical values are at T_J = +25°C.

	PARAMETE	R 100	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{IN}	Input voltage	range ⁽¹⁾ (2)	100 WT 100	1.7	LTW	5.5	V
V_{FB}	Internal refere	ence (TPS73601)	$T_J = +25^{\circ}C$	1.198	1.20	1.210	V
COM	Output voltag (TPS73601) ⁽³	e range	OM. TW WWW.	V _{FB}	MTW	5.5 – V _{DO}	V
V _{OUT}	(1)	Nominal	$T_J = +25^{\circ}C$	-0.5	UP.	+0.5	
	Accuracy ⁽¹⁾	over V_{IN} , I_{OUT} , and T	$V_{OUT} + 0.5V \le V_{IN} \le 5.5V;$ 10mA \le I _{OUT} \le 400mA	-1.0	±0.5	+1.0	%
$\Delta V_{OUT}\%/\Delta V_{IN}$	Line regulation	on ⁽¹⁾	$V_{O(nom)} + 0.5V \le V_{IN} \le 5.5V$	1007	0.01	W	%/V
AV 0//AI	Lood rogulati	- XXXX 10	1mA ≤ I _{OUT} ≤ 400mA	M. Inc	0.002		0/ /22 Δ
$\Delta V_{OUT} \% / \Delta I_{OUT}$	Load regulation	on	10mA ≤ I _{OUT} ≤ 400mA	TN.100	0.0005	II.	%/mA
V _{DO}	Dropout volta		I _{OUT} = 400mA	WW.10	75	200	mV
Z _O (DO)	Output imped	lance in dropout	$1.7V \le V_{IN} \le V_{OUT} + V_{DO}$	1	0.25	M.I.	Ω
M. CON.C	Output ourran	at limit	$V_{OUT} = 0.9 \times V_{OUT(nom)}$	400	650	800	mA
I _{CL}	Output currer	IL IIITIIL	$3.6V \le V_{IN} \le 4.2V, 0^{\circ}C \le T_{J} \le +70^{\circ}C$	500	. ON C	800	mA
I _{SC}	Short-circuit of	current	V _{OUT} = 0V		450	OM	mA
I _{REV}	Reverse leak	age current ⁽⁶⁾ (-I _{IN})	$V_{EN} \le 0.5V$, $0V \le V_{IN} \le V_{OUT}$	W T	0.1	10	μΑ
MM.	OND	CW W	$I_{OUT} = 10 \text{mA} (I_Q)$	MM	400	550	N .
I _{GND}	GND pin curr	ent	I _{OUT} = 400mA	W	800	1000	μΑ
I _{SHDN}	Shutdown cu	rrent (I _{GND})	$V_{EN} \le 0.5V$, $V_{OUT} \le V_{IN} \le 5.5$, -40°C $\le T_J \le +100$ °C	W	0.02	Y.CPM	μΑ
I _{FB}	FB pin curren	nt (TPS73601)	TIMN TO COM		0.1	0.3	μΑ
DODD	Power-supply	rejection ratio	f = 100Hz, I _{OUT} = 400mA		58	=1 CO	JD(X)
PSRR	(ripple rejection		f = 10KHz, I _{OUT} = 400mA		37	100 1.	dB
v www	Output noise	voltage	$C_{OUT} = 10\mu F$, No C_{NR}	1	$27 \times V_{OUT}$	1001.0	TV
V_N	BW = 10Hz -	- 100KHz	$C_{OUT} = 10\mu F, C_{NR} = 0.01\mu F$	· KN	$8.5 \times V_{OUT}$	0.7.0	μV_{RMS}
t _{STR}	Startup time	COMITY	$\begin{split} V_{OUT} = 3V, \ R_L = 30\Omega \ C_{OUT} = 1 \mu F, \\ C_{NR} = 0.01 \mu F \end{split}$		600	N.100X	COμs
V _{EN} (HI)	EN pin high (enabled)	MAN TOO COM	1.7	WV	V _{IN}	CV
V _{EN} (LO)	EN pin low (s	hutdown)	100 COV	0	-17	0.5	V
I _{EN} (HI)	EN pin currer	nt (enabled)	V _{EN} = 5.5V	MTM	0.02	0.1	μΑ
т	Thormal short	davia tana aratum	Shutdown, temperature increasing	WT	+160	1111	0700
T _{SD}	i nermai snut	down temperature	Reset, temperature decreasing	OMr.	+140		°C
TJ	Operating jun	ction temperature	M. M. 1003.	-40	4	+125	.C

Minimum $V_{IN} = V_{OUT} + V_{DO}$ or 1.7V, whichever is greater. For $V_{OUT(nom)} < 1.6V$, when $V_{IN} \le 1.6V$, the output will lock to V_{IN} and may result in a damaging over-voltage level on the output. To avoid this stinction, disable the device before powering down the V_{IN} . (2)

TPS73601 is tested at $V_{OUT} = 2.5V$.

Tolerance of external resistors not included in this specification.

(5) V_{DO} is not measured for fixed output versions with $\dot{V}_{OUT(nom)}$ < 1.8V.

Fixed-voltage versions only; refer to Applications section for more information.

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FUNCTIONAL BLOCK DIAGRAMS

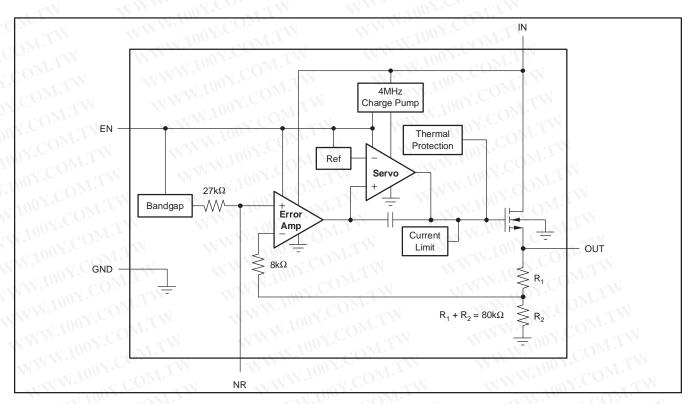


Figure 1. Fixed Voltage Version

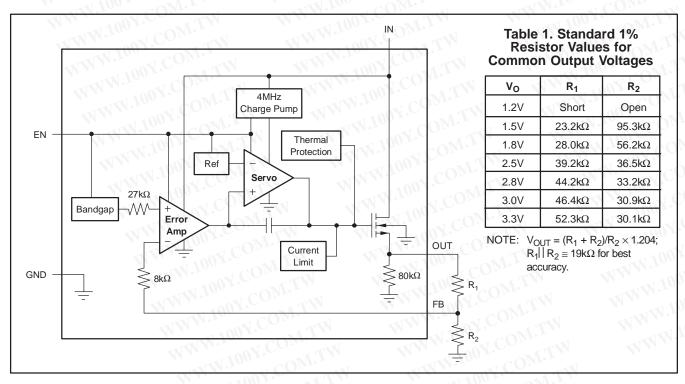
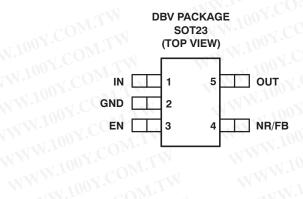
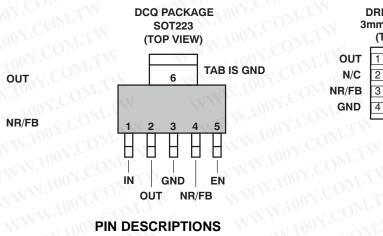


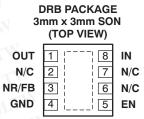
Figure 2. Adjustable Voltage Version



PIN CONFIGURATIONS







PIN DESCRIPTIONS

1007.	MILMO	1	Y 100	PIN DESCRIPTIONS
NAME	SOT23 (DBV) PIN NO.	SOT223 (DCQ) PIN NO.	3x3 SON (DRB) PIN NO.	DESCRIPTION
IN	CO1	1	8	Input supply
GND	2	3, 6	4, Pad	Ground
EN 10	0X.30M	5	5	Driving the enable pin (EN) high turns on the regulator. Driving this pin low puts the regulator into shutdown mode. Refer to the Shutdown section under Applications Information for more details. EN can be connected to IN if not used.
NR	0014	1.14	3	Fixed voltage versions only—connecting an external capacitor to this pin bypasse noise generated by the internal bandgap, reducing output noise to very low levels
FB	.1004	OM-4	3	Adjustable voltage version only—this is the input to the control loop error amplified and is used to set the output voltage of the device.
OUT	5	2	1	Output of the Regulator. There are no output capacitor requirements for stability.

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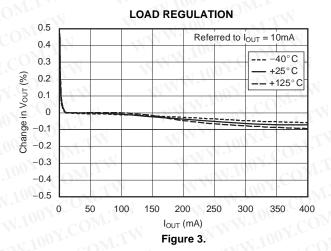
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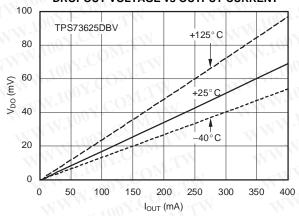
TYPICAL CHARACTERISTICS

For all voltage versions, at $T_J = +25^{\circ}C$, $V_{IN} = V_{OUT(nom)} + 0.5V$, $I_{OUT} = 10$ mA, $V_{EN} = 1.7V$, and $C_{OUT} = 0.1\mu$ F, unless otherwise noted.

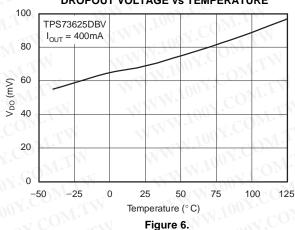


LINE REGULATION 0.20 Referred to $V_{IN} = V_{OUT} + 0.5V$ at $I_{OUT} = 10$ mA 0.15 0.10 Change in V_{OUT} (%) +125°C +25° C 0.05 0 -0.05-40° C -0.10-0.15-0.202.5 3.5 0.5 1.0 2.0 3.0 4.0 $V_{IN} - V_{OUT}(V)$ Figure 4.

DROPOUT VOLTAGE vs OUTPUT CURRENT

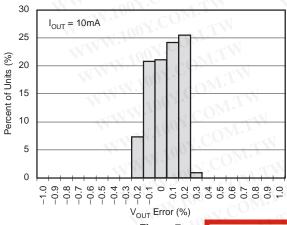


DROPOUT VOLTAGE vs TEMPERATURE

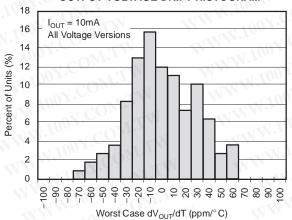


OUTPUT VOLTAGE ACCURACY HISTOGRAM

Figure 5.



OUTPUT VOLTAGE DRIFT HISTOGRAM

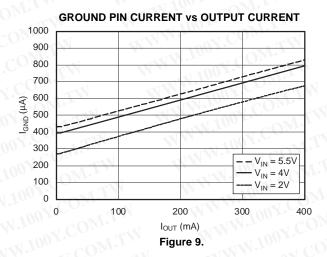


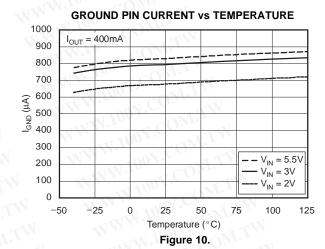
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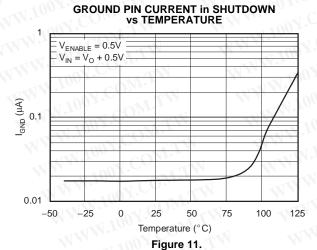
Figure 8.

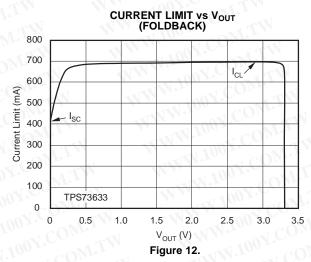


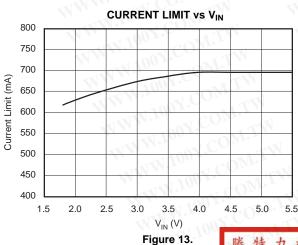
For all voltage versions, at T_J = +25°C, V_{IN} = $V_{OUT(nom)}$ + 0.5V, I_{OUT} = 10mA, V_{EN} = 1.7V, and C_{OUT} = 0.1 μ F, unless otherwise noted.

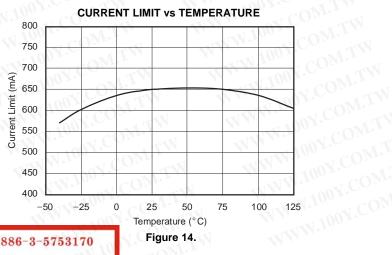












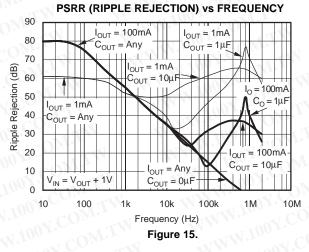
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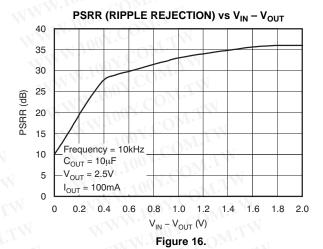
Figure 14.

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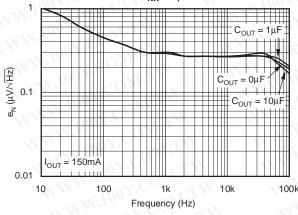


For all voltage versions, at T_J = +25°C, V_{IN} = $V_{OUT(nom)}$ + 0.5V, I_{OUT} = 10mA, V_{EN} = 1.7V, and C_{OUT} = 0.1 μ F, unless otherwise noted.





NOISE SPECTRAL DENSITY $C_{NR} = 0\mu F$



NOISE SPECTRAL DENSITY

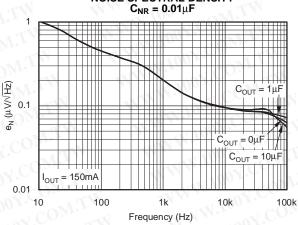


Figure 17.

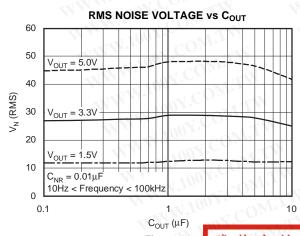


Figure 18.

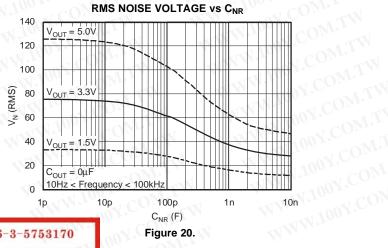


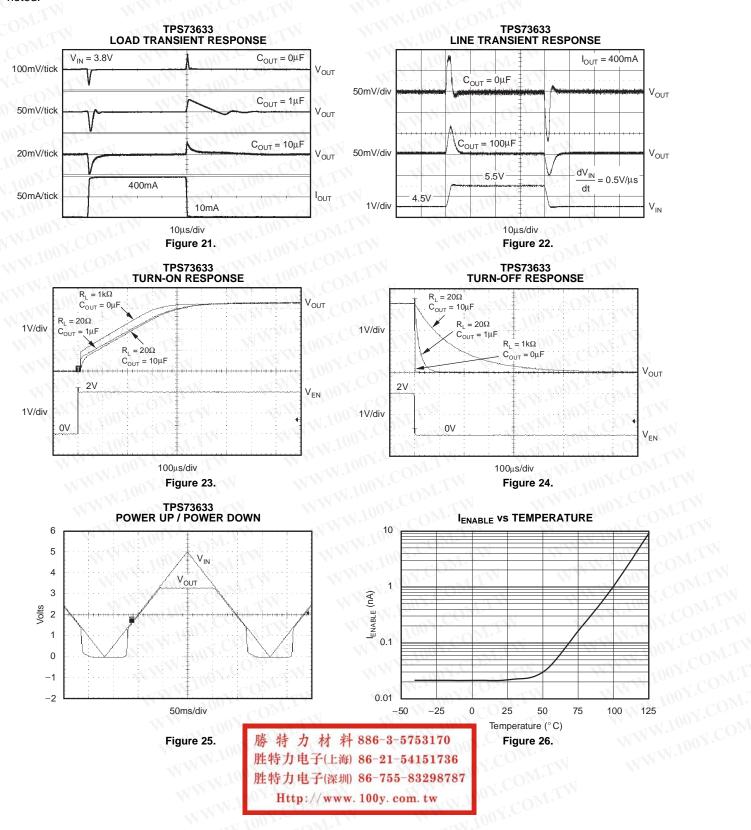
Figure 19.

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Figure 20.

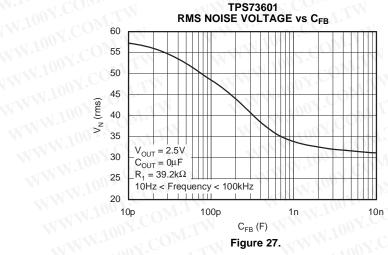


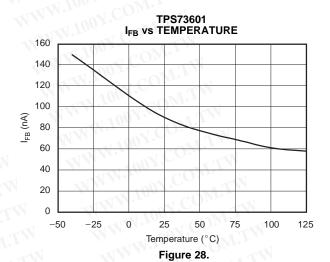
For all voltage versions, at $T_J = +25^{\circ}C$, $V_{IN} = V_{OUT(nom)} + 0.5V$, $I_{OUT} = 10$ mA, $V_{EN} = 1.7V$, and $C_{OUT} = 0.1\mu$ F, unless otherwise noted.





For all voltage versions, at T_J = +25°C, V_{IN} = $V_{OUT(nom)}$ + 0.5V, I_{OUT} = 10mA, V_{EN} = 1.7V, and C_{OUT} = 0.1 μ F, unless otherwise noted.





TPS73601 LOAD TRANSIENT, ADJUSTABLE VERSION $C_{FB} = 10nF$ $R_1 = 39.2k\Omega$ $C_{OUT} = 0\mu F$ 200mV/div $C_{OUT} = 10 \mu F$ 200mV/div V_{OUT} 400mA

Figure 29.

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25µs/div

10mA

TPS73601 LINE TRANSIENT, ADJUSTABLE VERSION

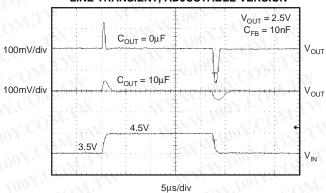


Figure 30.

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APPLICATION INFORMATION

The TPS736xx belongs to a family of new generation LDO regulators that use an NMOS pass transistor to achieve ultra-low-dropout performance, reverse current blockage, and freedom from output capacitor constraints. These features, combined with low noise and an enable input, make the TPS736xx ideal for portable applications. This regulator family offers a wide selection of fixed output voltage versions and an adjustable output version. All versions have thermal and over-current protection, including foldback current limit.

Figure 31 shows the basic circuit connections for the fixed voltage models. Figure 32 gives the connections for the adjustable output version (TPS73601).

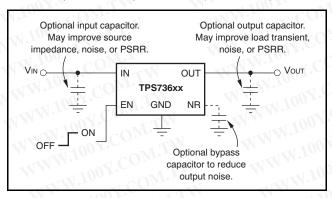


Figure 31. Typical Application Circuit for Fixed-Voltage Versions

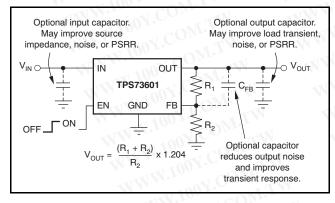


Figure 32. Typical Application Circuit for Adjustable-Voltage Version

 R_1 and R_2 can be calculated for any output voltage using the formula shown in Figure 32. Sample resistor values for common output voltages are shown in Figure 2.

For best accuracy, make the parallel combination of R_1 and R_2 approximately eugal to $19k\Omega.$ This $19k\Omega,$ in addition to the internal $8k\Omega$ resistor, presents the same impedance to the error amp as the $27k\Omega$ bandgap reference output. This impedance helps compensate for leakages into the error amp terminals.

INPUT AND OUTPUT CAPACITOR REQUIREMENTS

Although an input capacitor is not required for stability, it is good analog design practice to connect a 0.1 μF to 1 μF low ESR capacitor across the input supply near the regulator. This counteracts reactive input sources and improves transient response, noise rejection, and ripple rejection. A higher-value capacitor may be necessary if large, fast rise-time load transients are anticipated or the device is located several inches from the power source.

The TPS736xx does not require an output capacitor for stability and has maximum phase margin with no capacitor. It is designed to be stable for all available types and values of capacitors. In applications where multiple low ESR capacitors are in parallel, ringing may occur when the product of C_{OUT} and total ESR drops below $50n\Omega F.$ Total ESR includes all parasitic resistances, including capacitor ESR and board, socket, and solder joint resistance. In most applications, the sum of capacitor ESR and trace resistance will meet this requirement.

OUTPUT NOISE

A precision band-gap reference is used to generate the internal reference voltage, V_{REF} . This reference is the dominant noise source within the TPS736xx and it generates approximately $32\mu V_{RMS}$ (10Hz to 100kHz) at the reference output (NR). The regulator control loop gains up the reference noise with the same gain as the reference voltage, so that the noise voltage of the regulator is approximately given by:

$$V_{N} = 32\mu V_{RMS} \times \frac{(R_{1} + R_{2})}{R_{2}} = 32\mu V_{RMS} \times \frac{V_{OUT}}{V_{REF}}$$
 (1)

Since the value of V_{REF} is 1.2V, this relationship reduces to:

$$V_{N}(\mu V_{RMS}) = 27 \left(\frac{\mu V_{RMS}}{V}\right) \times V_{OUT}(V)$$
 (2)

for the case of no C_{NR} .



An internal $27k\Omega$ resistor in series with the noise reduction pin (NR) forms a low-pass filter for the voltage reference when an external noise reduction capacitor, C_{NR} , is connected from NR to ground. For $C_{NR} = 10$ nF, the total noise in the 10Hz to 100kHz bandwidth is reduced by a factor of ~3.2, giving the approximate relationship:

$$V_{N}(\mu V_{RMS}) = 8.5 \left(\frac{\mu V_{RMS}}{V}\right) \times V_{OUT}(V)$$
 (3)

for $C_{NR} = 10nF$.

This noise reduction effect is shown as RMS Noise Voltage vs C_{NR} in the Typical Characteristics section.

The TPS73601 adjustable version does not have the NR pin available. However, connecting a feedback capacitor, C_{FB} , from the output to the feedback pin (FB) reduces output noise and improves load transient performance.

The TPS736xx uses an internal charge pump to develop an internal supply voltage sufficient to drive the gate of the NMOS pass element above $V_{OUT}.$ The charge pump generates ${\sim}250\mu V$ of switching noise at ${\sim}4MHz;$ however, charge-pump noise contribution is negligible at the output of the regulator for most values of I_{OUT} and $C_{OUT}.$

BOARD LAYOUT RECOMMENDATION TO IMPROVE PSRR AND NOISE PERFORMANCE

To improve ac performance such as PSRR, output noise, and transient response, it is recommended that the board be designed with separate ground planes for V_{IN} and V_{OUT} , with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor should connect directly to the GND pin of the device.

INTERNAL CURRENT LIMIT

The TPS736xx internal current limit helps protect the regulator during fault conditions. Foldback current limit helps to protect the regulator from damage during output short-circuit conditions by reducing current limit when V_{OUT} drops below 0.5V. See Figure 12 in the Typical Characteristics section.

ENABLE PIN AND SHUTDOWN

The enable pin (EN) is active high and is compatible with standard TTL-CMOS levels. A $V_{\rm EN}$ below 0.5V (max) turns the regulator off and drops the GND pin current to approximately 10nA. When EN is used to shutdown the regulator, all charge is removed from the pass transistor gate, and the output ramps back up to a regulated $V_{\rm OUT}$ (see Figure 23).

When shutdown capability is not required, EN can be connected to V_{IN} . However, the pass gate may not be discharged using this configuration, and the pass transistor may be left on (enhanced) for a significant time after V_{IN} has been removed. This scenario can result in reverse current flow (if the IN pin is low impedance) and faster ramp times upon power-up. In addition, for V_{IN} ramp times slower than a few milliseconds, the output may overshoot upon power-up.

DROPOUT VOLTAGE

The TPS736xx uses an NMOS pass transistor to achieve extremely low dropout. When $(V_{\text{IN}} - V_{\text{OUT}})$ is less than the dropout voltage (V_{DO}) , the NMOS pass device is in its linear region of operation and the input-to-output resistance is the $R_{\text{DS-ON}}$ of the NMOS pass element.

For large step changes in load current, the TPS736xx requires a larger voltage drop from V_{IN} to V_{OUT} to avoid degraded transient response. The boundary of this transient dropout region is approximately twice the dc dropout. Values of $V_{\text{IN}} - V_{\text{OUT}}$ above this line ensure normal transient response.

Operating in the transient dropout region can cause an increase in recovery time. The time required to recover from a load transient is a function of the magnitude of the change in load current rate, the rate of change in load current, and the available headroom (V_{IN} to V_{OUT} voltage drop). Under worst-case conditions [full-scale instantaneous load change with ($V_{\text{IN}}-V_{\text{OUT}}$) close to dc dropout levels], the TPS736xx can take a couple of hundred microseconds to return to the specified regulation accuracy.

TRANSIENT RESPONSE

The low open-loop output impedance provided by the NMOS pass element in a voltage follower configuration allows operation without an output capacitor for many applications. As with any regulator, the addition of a capacitor (nominal value $1\mu F$) from the OUT pin to ground will reduce undershoot magnitude but increase its duration. In the adjustable version, the addition of a capacitor, C_{FB} , from the OUT pin to the FB pin will also improve the transient response.

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The TPS736xx does not have active pull-down when the output is over-voltage. This allows applications that connect higher voltage sources, such as alternate power supplies, to the output. This also results in an output overshoot of several percent if load current quickly drops to zero when a capacitor is connected to the output. The duration of overshoot can be reduced by adding a load resistor. The overshoot decays at a rate determined by output capacitor C_{OUT} and the internal/external load resistance. The rate of decay is given by:

(Fixed Voltage Version)

$$dV/dt = \frac{V_{OUT}}{C_{OUT} \times 80k\Omega \parallel R_{LOAD}}$$
(4)

(Adjustable Voltage Version)

$$dV/dt = \frac{V_{OUT}}{C_{OUT} \times 80k\Omega \parallel (R_1 + R_2) \parallel R_{LOAD}}$$
 (5)

REVERSE CURRENT

The NMOS pass element of the TPS736xx provides inherent protection against current flow from the output of the regulator to the input when the gate of the pass device is pulled low. To ensure that all charge is removed from the gate of the pass element, the EN pin must be driven low before the input voltage is removed. If this is not done, the pass element may be left on due to stored charge on the gate.

After the EN pin is driven low, no bias voltage is needed on any pin for reverse current blocking. Note that reverse current is specified as the current flowing out of the IN pin due to voltage applied on the OUT pin. There will be additional current flowing into the OUT pin due to the $80k\Omega$ internal resistor divider to ground (see Figure 1 and Figure 2).

For the TPS73601, reverse current may flow when V_{FB} is more than 1.0V above V_{IN} .

THERMAL PROTECTION

Thermal protection disables the output when the junction temperature rises to approximately +160°C, allowing the device to cool. When the junction temperature cools to approximately +140°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This limits the dissipation of the regulator, protecting it from damage due to overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heat sink. For reliable operation, junction temperature should be limited to +125°C maximum. To estimate the margin of safety in a complete design (including heat sink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, thermal protection should trigger at least +35°C above the maximum expected ambient condition of your application. This produces a worst-case junction temperature of +125°C at the highest expected ambient temperature worst-case load.

The internal protection circuitry of the TPS736xx has been designed to protect against overload conditions. It was not intended to replace proper heat sinking. Continuously running the TPS736xx into thermal shutdown degrades device reliability.

POWER DISSIPATION

The ability to remove heat from the die is different for each package type, presenting different considerations in the PCB layout. The PCB area around the device that is free of other components moves the heat from the device to the ambient air. Performance data for JEDEC low- and high-K boards are shown in the Power Dissipation Ratings table. Using heavier copper will increase the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers will also improve the heat-sink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation (P_D) is equal to the product of the output current times the voltage drop across the output pass element (V_{IN} to V_{OUT}):

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT}$$
 (6)

Power dissipation can be minimized by using the lowest possible input voltage necessary to assure the required output voltage.

PACKAGE MOUNTING

Solder pad footprint recommendations for the TPS736xx are presented in Application Bulletin Solder Pad Recommendations for Surface-Mount Devices (SBFA015), available from the Texas Instruments web site at www.ti.com.

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PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³
TPS73601DBVR	ACTIVE	SOT-23	DBV	5		Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73601DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73601DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73601DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73601DCQ	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DCQG4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DCQR	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DRBR	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DRBRG4	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DRBT	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73601DRBTG4	ACTIVE	SON	DRB	80	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS736125DRBR	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS736125DRBRG4	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS736125DRBT	ACTIVE	SON	DRB	108	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS736125DRBTG4	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73615DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73615DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73615DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73615DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73615DCQ	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAI
TPS73615DCQG4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAI
TPS73615DCQR	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAI
TPS73615DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAI
TPS73615DRBR	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAI
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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TPS73615DRBRG4	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73615DRBT	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73615DRBTG4	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73618DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73618DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73618DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73618DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73618DCQ	ACTIVE	SOT-223	DCQ	6	78		CU NIPDAU	Level-2-260C-1 YEAR
TPS73618DCQG4	ACTIVE	SOT-223	DCQ	6	78		CU NIPDAU	Level-2-260C-1 YEAR
TPS73618DCQR	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73618DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73619DRBR	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73619DRBRG4	ACTIVE	SON	DRB	80	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73619DRBT	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73619DRBTG4	ACTIVE	SON	DRB	008	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73625DBVR	ACTIVE	SOT-23	DBV	105	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73625DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73625DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73625DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73625DCQ	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73625DCQG4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73625DCQR	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73625DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73630DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73630DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73630DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TPS73615DRBT TPS73615DRBTG4 TPS73618DBVR TPS73618DBVRG4 TPS73618DBVTG4 TPS73618DCQ TPS73618DCQR TPS73618DCQRG4 TPS73618DCQRG4 TPS73619DRBR TPS73619DRBR TPS73619DRBT TPS73625DBVR TPS73625DBVT TPS73625DCQR TPS73625DCQR TPS73625DCQRG4 TPS73625DCQRG4 TPS73625DCQRG4	TPS73615DRBT ACTIVE TPS73615DRBTG4 ACTIVE TPS73618DBVR ACTIVE TPS73618DBVRG4 ACTIVE TPS73618DBVTG4 ACTIVE TPS73618DBVTG4 ACTIVE TPS73618DCQG4 ACTIVE TPS73618DCQRG4 ACTIVE TPS73618DCQRG4 ACTIVE TPS73619DRBR ACTIVE TPS73619DRBRG4 ACTIVE TPS73619DRBTG4 ACTIVE TPS73625DBVR ACTIVE TPS73625DBVRG4 ACTIVE TPS73625DBVTG4 ACTIVE TPS73625DBVTG4 ACTIVE TPS73625DCQ ACTIVE TPS73625DCQG4 ACTIVE TPS73625DCQRG4 ACTIVE TPS73625DCQRG4 ACTIVE TPS73625DCQRG4 ACTIVE TPS73625DCQRG4 ACTIVE TPS73625DCQRG4 ACTIVE TPS73630DBVR ACTIVE	TPS73615DRBRG4 ACTIVE SON TPS73615DRBT ACTIVE SON TPS73615DRBTG4 ACTIVE SON TPS73618DBVR ACTIVE SOT-23 TPS73618DBVRG4 ACTIVE SOT-23 TPS73618DBVTG4 ACTIVE SOT-23 TPS73618DBVTG4 ACTIVE SOT-23 TPS73618DCQ ACTIVE SOT-223 TPS73618DCQG4 ACTIVE SOT-223 TPS73618DCQRG4 ACTIVE SOT-223 TPS73619DRBR ACTIVE SON TPS73619DRBR ACTIVE SON TPS73619DRBTG4 ACTIVE SON TPS73619DRBTG4 ACTIVE SON TPS73625DBVR ACTIVE SOT-23 TPS73625DBVRG4 ACTIVE SOT-23 TPS73625DBVTG4 ACTIVE SOT-23 TPS73625DCQA ACTIVE SOT-223 TPS73625DCQG4 ACTIVE SOT-223 TPS73625DCQRG4 ACTIVE SOT-223 TPS73625DCQRG4 ACTIVE SOT-223 </td <td>TPS73615DRBRG4 ACTIVE SON DRB TPS73615DRBT ACTIVE SON DRB TPS73615DRBTG4 ACTIVE SON DRB TPS73618DBVR ACTIVE SOT-23 DBV TPS73618DBVRG4 ACTIVE SOT-23 DBV TPS73618DBVTG4 ACTIVE SOT-23 DBV TPS73618DBVTG4 ACTIVE SOT-23 DBV TPS73618DCQG4 ACTIVE SOT-223 DCQ TPS73618DCQG4 ACTIVE SOT-223 DCQ TPS73618DCQRG4 ACTIVE SOT-223 DCQ TPS73619DRBR ACTIVE SON DRB TPS73619DRBRG4 ACTIVE SON DRB TPS73619DRBTG4 ACTIVE SON DRB TPS73625DBVR ACTIVE SOT-23 DBV TPS73625DBVRG4 ACTIVE SOT-23 DBV TPS73625DCQA ACTIVE SOT-23 DBV TPS73625DCQG4 ACTIVE SOT-223 DCQ TPS73625DC</td> <td>TPS73615DRBRG4 ACTIVE SON DRB 8 TPS73615DRBT ACTIVE SON DRB 8 TPS73615DRBTG4 ACTIVE SON DRB 8 TPS73615DRBTG4 ACTIVE SOT-23 DBV 5 TPS73618DBVRG4 ACTIVE SOT-23 DBV 5 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 TPS73618DCQQ ACTIVE SOT-23 DCQ 6 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 TPS73618DCQRG4 ACTIVE SOT-223 DCQ 6 TPS73619DRBR ACTIVE SOT-223 DCQ 6 TPS73619DRBRG4 ACTIVE SON DRB 8 TPS73619DRBTG4 ACTIVE SON DRB 8 TPS73625DBVR ACTIVE SOT-23 DBV <</td> <td>TPS73615DRBRG4 ACTIVE SON DRB 8 3000 TPS73615DRBT ACTIVE SON DRB 8 250 TPS73615DRBTG4 ACTIVE SON DRB 8 250 TPS73618DBVR ACTIVE SOT-23 DBV 5 3000 TPS73618DBVRG4 ACTIVE SOT-23 DBV 5 3000 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 250 TPS73618DCQA ACTIVE SOT-23 DBV 5 250 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 78 TPS73618DCQRG4 ACTIVE SOT-223 DCQ 6 2500 TPS73619DRBR ACTIVE SOT-223 DCQ 6 2500 TPS73619DRBRG4 ACTIVE SON DRB 8 3000 TPS73619DRBTG4 ACTIVE SON DRB 8 250 TPS73625DBVR ACTIVE SOT-23 DBV 5 3</td> <td> TPS73615DRBRG4</td> <td> TPS73615DRBRG4</td>	TPS73615DRBRG4 ACTIVE SON DRB TPS73615DRBT ACTIVE SON DRB TPS73615DRBTG4 ACTIVE SON DRB TPS73618DBVR ACTIVE SOT-23 DBV TPS73618DBVRG4 ACTIVE SOT-23 DBV TPS73618DBVTG4 ACTIVE SOT-23 DBV TPS73618DBVTG4 ACTIVE SOT-23 DBV TPS73618DCQG4 ACTIVE SOT-223 DCQ TPS73618DCQG4 ACTIVE SOT-223 DCQ TPS73618DCQRG4 ACTIVE SOT-223 DCQ TPS73619DRBR ACTIVE SON DRB TPS73619DRBRG4 ACTIVE SON DRB TPS73619DRBTG4 ACTIVE SON DRB TPS73625DBVR ACTIVE SOT-23 DBV TPS73625DBVRG4 ACTIVE SOT-23 DBV TPS73625DCQA ACTIVE SOT-23 DBV TPS73625DCQG4 ACTIVE SOT-223 DCQ TPS73625DC	TPS73615DRBRG4 ACTIVE SON DRB 8 TPS73615DRBT ACTIVE SON DRB 8 TPS73615DRBTG4 ACTIVE SON DRB 8 TPS73615DRBTG4 ACTIVE SOT-23 DBV 5 TPS73618DBVRG4 ACTIVE SOT-23 DBV 5 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 TPS73618DCQQ ACTIVE SOT-23 DCQ 6 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 TPS73618DCQRG4 ACTIVE SOT-223 DCQ 6 TPS73619DRBR ACTIVE SOT-223 DCQ 6 TPS73619DRBRG4 ACTIVE SON DRB 8 TPS73619DRBTG4 ACTIVE SON DRB 8 TPS73625DBVR ACTIVE SOT-23 DBV <	TPS73615DRBRG4 ACTIVE SON DRB 8 3000 TPS73615DRBT ACTIVE SON DRB 8 250 TPS73615DRBTG4 ACTIVE SON DRB 8 250 TPS73618DBVR ACTIVE SOT-23 DBV 5 3000 TPS73618DBVRG4 ACTIVE SOT-23 DBV 5 3000 TPS73618DBVTG4 ACTIVE SOT-23 DBV 5 250 TPS73618DCQA ACTIVE SOT-23 DBV 5 250 TPS73618DCQG4 ACTIVE SOT-223 DCQ 6 78 TPS73618DCQRG4 ACTIVE SOT-223 DCQ 6 2500 TPS73619DRBR ACTIVE SOT-223 DCQ 6 2500 TPS73619DRBRG4 ACTIVE SON DRB 8 3000 TPS73619DRBTG4 ACTIVE SON DRB 8 250 TPS73625DBVR ACTIVE SOT-23 DBV 5 3	TPS73615DRBRG4	TPS73615DRBRG4



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PACKAGE OPTION ADDENDUM

18-Sep-2008

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
TPS73630DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73630DCQ	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAF
TPS73630DCQG4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAF
TPS73630DCQR	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73630DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73632DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73632DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73632DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73632DBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73633DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73633DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73633DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73633DBVTG4	ACTIVE	SOT-23	DBV	50	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS73633DCQ	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DCQG4	ACTIVE	SOT-223	DCQ	6	78	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DCQR	ACTIVE	SOT-223	DCQ	106	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DCQRG4	ACTIVE	SOT-223	DCQ	6	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DRBR	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DRBRG4	ACTIVE	SON	DRB	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
TPS73633DRBT	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAF
TPS73633DRBTG4	ACTIVE	SON	DRB	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAF
TPS73643DBVR	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI
TPS73643DBVRG4	ACTIVE	SOT-23	DBV	5	3000	TBD	Call TI	Call TI
TPS73643DBVT	ACTIVE	SOT-23	DBV	5	250	TBD	Call TI	Call TI
TPS73643DBVTG4	ACTIVE	SOT-23	DBV	5 🕥	250	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.





18-Sep-2008

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TPS73601, TPS73615, TPS73618, TPS73625, TPS73630, TPS73632, TPS73633:

Enhanced Product: TPS73601-EP, TPS73615-EP, TPS73618-EP, TPS73625-EP, TPS73630-EP, TPS73632-EP, TPS73633-EP

NOTE: Qualified Version Definitions:

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• Enhanced Product - Supports Defense, Aerospace and Medical Applications

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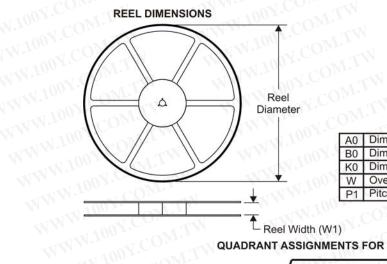
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PACKAGE MATERIALS INFORMATION

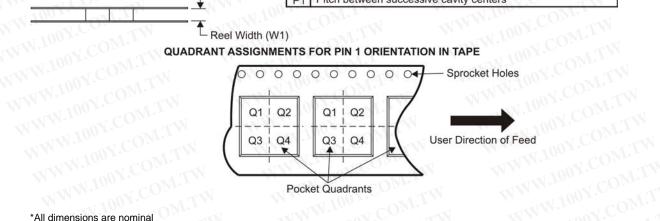
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TAPE AND REEL INFORMATION



TAPE DIMENSIONS ★ K0 ◆ 0 $\phi \phi \phi \phi$ → A0 ←

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
D1	Pitch hetween successive cavity centers



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imensions are nomina Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadra
TPS73601DBVR	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73601DBVT	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73601DCQR	SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73601DRBR	SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS73601DRBT	SON	DRB	8	250	180.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS736125DRBR	SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS736125DRBT	SON	DRB	8	250	180.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS73615DBVR	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73615DBVT	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73615DCQR	SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73615DRBR	SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS73615DRBT	SON	DRB	8	250	180.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS73618DBVR	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73618DBVT	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73618DCQR	SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73619DRBR	SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.0	8.0	12.0	Q2
TPS73619DRBT	SON	DRB	8	250	180.0	12.4	3.3	3.3	1.0	8.0	12.0	Q2
TPS73625DBVR	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

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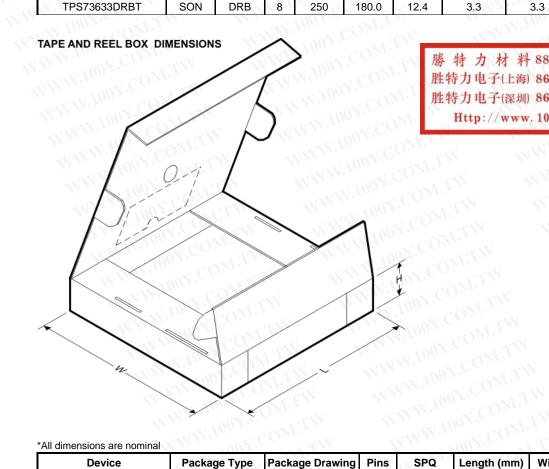
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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS73625DE	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73625D0	QR SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73630DE	SVR SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73630DE	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73630D0	QR SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73632DE	SVR SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73632DE	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73633DE	SVR SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73633DE	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS73633DC	QR SOT-223	DCQ	6	2500	330.0	12.4	6.8	7.3	1.88	8.0	12.0	Q3
TPS73633DF	RBR SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS73633DF	RBR SON	DRB	8	3000	330.0	12.4	3.3	3.3	1.0	8.0	12.0	Q2
TPS73633DF	RBT SON	DRB	8	250	180.0	12.4	3.3	3.3	1.0	8.0	12.0	Q2
TPS73633DF	RBT SON	DRB	8	250	180.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2



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ensions are nominal	1 1111	COSTAN	V	M. A.	1007.00	TW	1100
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PS73601DBVR	SOT-23	DBV	5	3000	195.0	200.0	45.0
PS73601DBVT	SOT-23	DBV	5	250	195.0	200.0	45.0
PS73601DCQR	SOT-223	DCQ	6	2500	358.0	335.0	35.0



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6-Nov-2008

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS73601DRB	R SON	DRB	8	3000	346.0	346.0	29.0
TPS73601DRB	T SON	DRB	8	250	190.5	212.7	31.8
TPS736125DRB	BR SON	DRB	8	3000	346.0	346.0	29.0
TPS736125DRE	SON SON	DRB	8	250	190.5	212.7	31.8
TPS73615DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73615DBV	T SOT-23	DBV	5	250	195.0	200.0	45.0
TPS73615DCQ	R SOT-223	DCQ	6	2500	358.0	335.0	35.0
TPS73615DRB	R SON	DRB	8	3000	346.0	346.0	29.0
TPS73615DRB	T SON	DRB	8	250	190.5	212.7	31.8
TPS73618DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73618DBV	T SOT-23	DBV	5	250	195.0	200.0	45.0
TPS73618DCQ	R SOT-223	DCQ	6	2500	358.0	335.0	35.0
TPS73619DRB	R SON	DRB	8	3000	370.0	355.0	55.0
TPS73619DRB	T SON	DRB	8	250	220.0	205.0	50.0
TPS73625DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73625DBV	T SOT-23	DBV	5	250	195.0	200.0	45.0
TPS73625DCQ	R SOT-223	DCQ	6	2500	358.0	335.0	35.0
TPS73630DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73630DBV	T SOT-23	DBV	5	250	195.0	200.0	45.0
TPS73630DCQ	R SOT-223	DCQ	6	2500	358.0	335.0	35.0
TPS73632DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73632DBV	T SOT-23	DBV	5 0	250	195.0	200.0	45.0
TPS73633DBVI	R SOT-23	DBV	5	3000	195.0	200.0	45.0
TPS73633DBV	T SOT-23	DBV	5	250	195.0	200.0	45.0
TPS73633DCQ	R SOT-223	DCQ	6	2500	358.0	335.0	35.0
TPS73633DRB	R SON	DRB	8	3000	346.0	346.0	29.0
TPS73633DRB	R SON	DRB	8	3000	370.0	355.0	55.0
TPS73633DRB	T SON	DRB	8	250	220.0	205.0	50.0
TPS73633DRB	T SON	DRB	8	250	190.5	212.7	31.8

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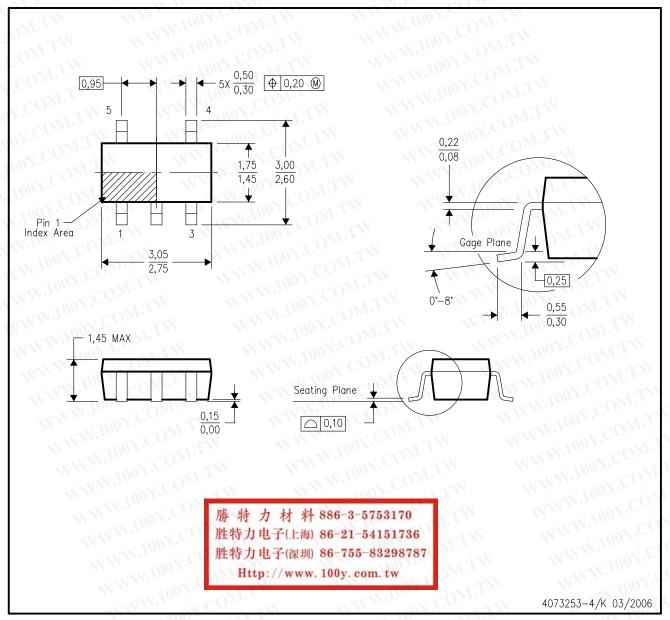
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DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- S: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.

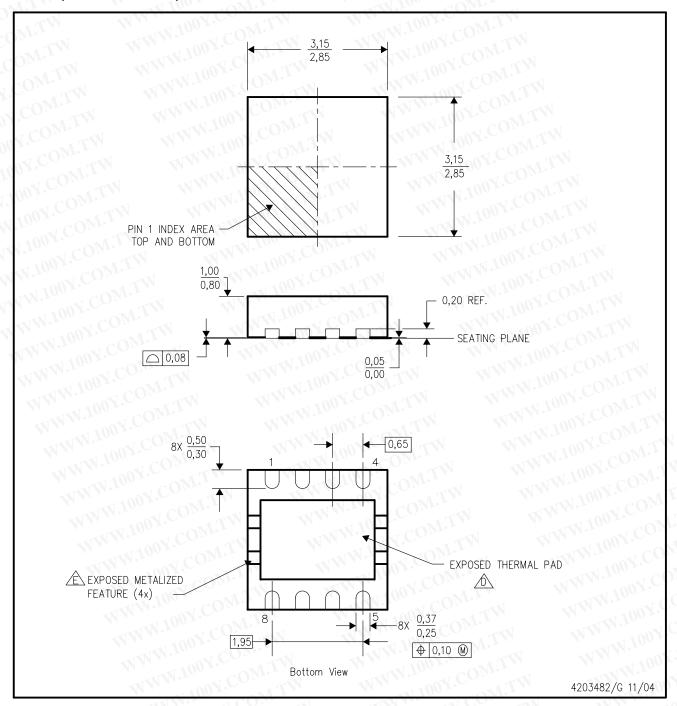


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DRB (S-PDSO-N8)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- C. Small Outline No-Lead (SON) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance.

 See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
- Metalized features are supplier options and may not be on the package.





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THERMAL PAD MECHANICAL DATA

(S-VSON-N8)

THERMAL INFORMATION

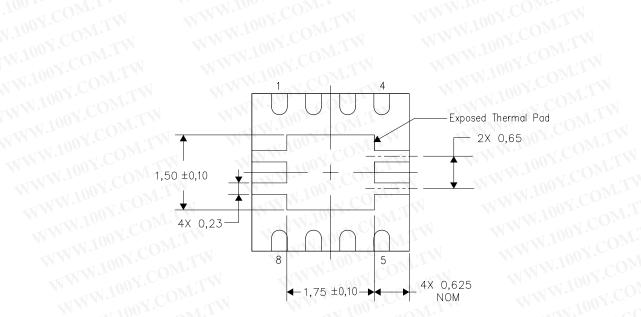
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This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available The exposed thermal pad dimensions for this package are shown in the following illustration.

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NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions WWW.100Y.COM.TW WWW.100Y.COM.TW

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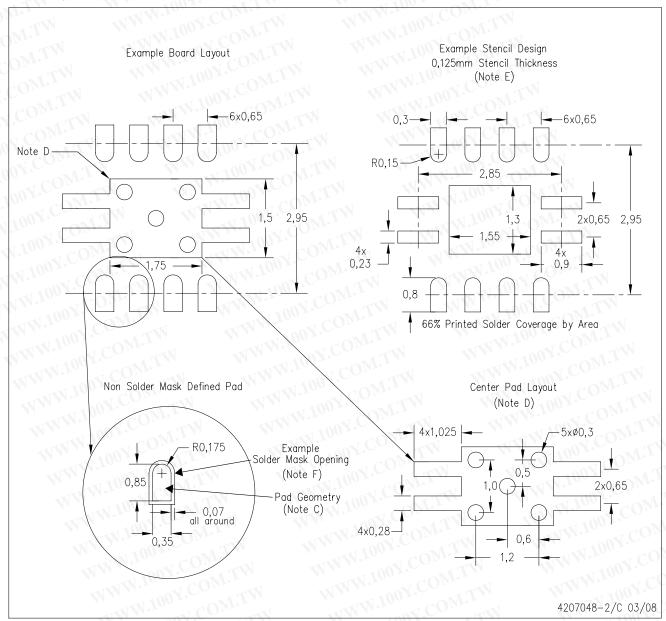
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DRB (S-VSON-N8)



All linear dimensions are in millimeters.

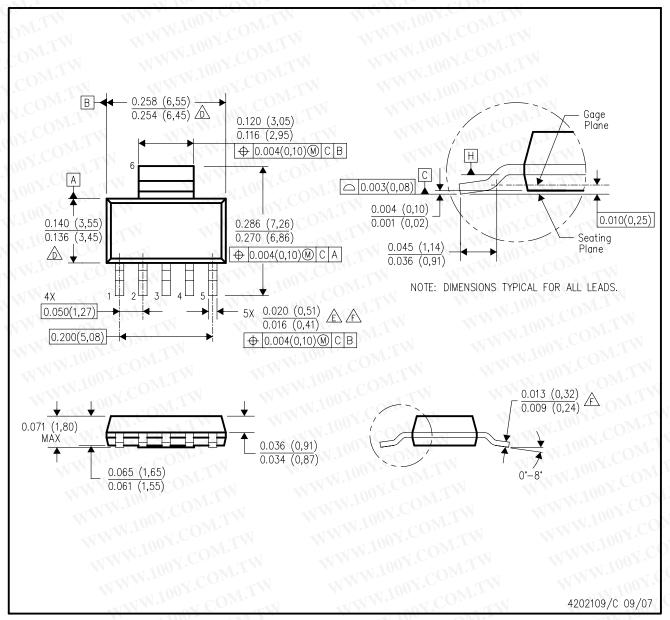
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, QFN Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com http://www.ti.com.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should WW.100Y.C contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- Customers should contact their board fabrication site for solder mask tolerances.



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DCQ (R-PDSO-G6)

PLASTIC SMALL-OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Controlling dimension in inches.
- Body length and width dimensions are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs, and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
- Lead width dimension does not include dambar protrusion.
- Lead width and thickness dimensions apply to solder plated leads.
- G. Interlead flash allow 0.008 inch max.
- H. Gate burr/protrusion max. 0.006 inch.
- I. Datums A and B are to be determined at Datum H.



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